San Francisco California 94111 T: 415-217-6000 F: 415-434-0646 Austin, TX San Jose, CA Newport Beach, CA skjerven morrill macpherson IIP

Docket No.: M-12467 US

January 24, 2002

Box Patent Application Commissioner For Patents Washington, D. C. 20231

Enclosed herewith for filing is a patent application, as follows:

Inventor:

Renken, Wayne

Title:

PROCESS CONDITION SENSING WAFER AND DATA ANALYSIS SYSTEM

<u>X</u>

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This Transmittal Letter (in duplicate) page(s) Specification (not including claims)

7

page(s) Claims

1

page Abstract Sheet(s) of Drawings

10

page NonPublication Request

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Applicant asserts entitlement to small entity status for the attached patent application

CLAIMS AS FILED (fees computed under 37 CFR §1.9(f))

CLAIMS AS TILED (lees computed under 37 CFR §1.9(1))									
	Number			Number					Basic Fee
<u>For</u>	<u>Filed</u>			<u>Extra</u>		<u>Rate</u>		\$	370.00
Total Claims	45	-20	=	25	x	\$ 9.00	=	\$	225.00
Independent	3	-3	=	0	x	\$42.00	=	\$	0.00
Claims									
Fee of for the first filing of one or more						\$			
multiple dependent claims per application									
Fee for Request for Extension of Time							\$		
Please make the following charges to Deposit Account 19-2386.									
Total fee for filing the patent application in the amount of							\$	595.00	
The Commissioner is hereby authorized to charge any additional fees which may be									
required, or credit any overpayment to Deposit Account 19-2386.									

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Respectfully submitted,

Peter G. Mikhail Agent

Reg. No. 46,930

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REQUEST AND CERTIFICATION UNDER 35 U.S.C. 122(b)(2)(B)(i)

Inventor		WAYNE RENKEN					
Title	PROCESS CONDITION SENSING WAFER AND DATA ANALYSIS SYSTEM						
Atty Docket Number			M-12467 US				

I hereby certify that the invention disclosed in the attached application has not and will not be the subject of an application filed in another country, or under a multilateral agreement, that requires publication at eighteen months after filing. I hereby request that the attached application not be published under 35 U.S.C. 122(b).

January 24, 2002 Date

Peter G. Mikhail

Agent Reg. No.: 46,930

This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application **upon filing**.

Applicant may rescind this nonpublication request at any time. If applicant rescinds a request that an application not be published under 35 U.S.C. 122(b), the application will be scheduled for publication at eighteen months from the earliest claimed filing date for which a benefit is claimed.

If applicant subsequently files an application directed to the invention disclosed in the attached application in another country, or under a multilateral international agreement, that requires publication of applications eighteen months after filing, the applicant **must** notify the United States Patent and Trademark Office of such filing within forty-five (45) days after the date of the filing of such foreign or international application. **Failure to do so will result in abandonment of this application (35 U.S.C. 122(b)(2)(B)(iii)).**